

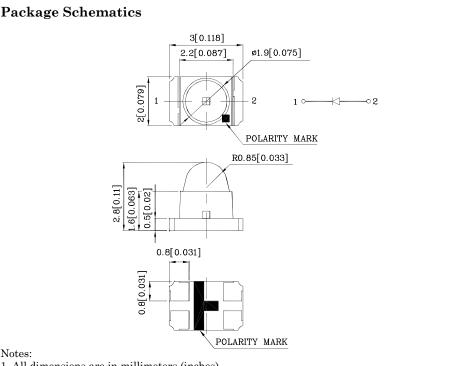
Part Number: ZM2ACY50WT-2

3.0x2.0mm RIGHT ANGLE SMD LED

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Tinned pads for improved solderability
- Package : 2000pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant





1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		M2ACY (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	\mathbf{I}_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA	
Power Dissipation	PD	75	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	-40 ~ +85	-0	

Operating Characteristics (T _A =25°C)		M2ACY (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2	V	
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V	
Reverse Current (Max.) (V _R =5V)	I_R	10	uA	
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	590	nm	
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	589	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	20	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	45	$_{\rm pF}$	

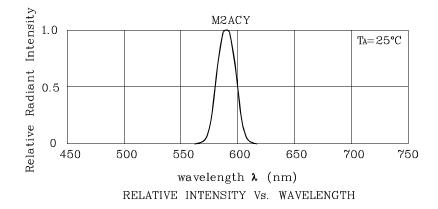
Part Number	Emitting Color	Emitting Material	Lens-color	Inter (I _F =2	inous nsity 0mA) cd	Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZM2ACY50WT-2	Yellow	AlGaInP	Water Clear	2300	3490	590	10°
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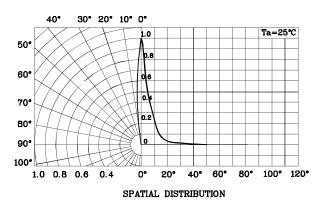
Apr 12,2011

SDSA8171 V1 Layout: Maggie L.

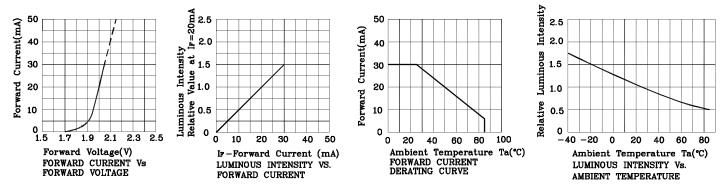
This datasheet has been downloaded from http://www.digchip.com at this page



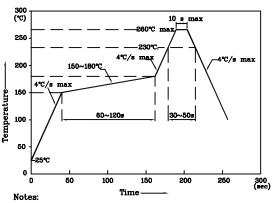




♦ M2ACY



LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

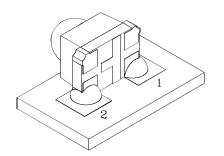
1. Maximum soldering temperature should not exceed 260°C 2. Recommended reflow temperature: 145°C-260°C

3. Do not put stress to the epoxy resin during

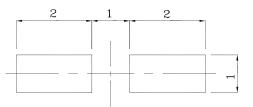
high temperatures conditions



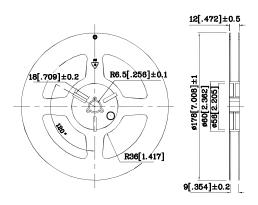
The device has a single mounting surface. The device must be mounted according to the specifications.



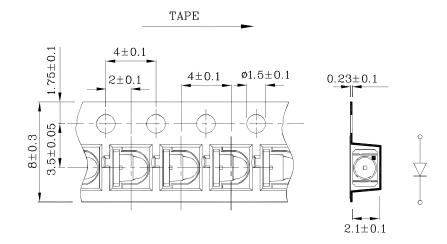
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS

